TR-75D

RF Transceiver Module

Data Sheet

Preliminary



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Description

TR-75D is a family of IQRF transceiver modules operating in the 868 MHz and 916 MHz license free ISM (Industry, Scientific and Medical) frequency band. Its highly integrated ready-to-use design containing MCU, RF circuitry, serial EEPROM and on-board antenna requires no external components. Vertical mounting and very small dimensions allow space saving. Extended RF power results in higher RF range. Extra low power consumption fits for battery powered applications. MCU with built-in operating system significantly reduces application development time. Optional DPA framework supports applications even without programming.

There is no difference between TR and DCTR transceiver versions from IQRF OS v4.02D. All TRs support both OS as well as DPA approaches.



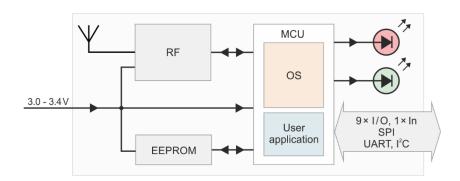
Key features

- Operating system (upgradeable at the user), easy to use
- DPA framework for Data controlled approach
- GFSK modulation
- Selectable RF band 868 / 916 MHz, multiple channel
- RF output power 10 mW
- MCU with extended resources, user interrupt capability
- Extra low power consumption, power management modes
- SPI interface supported by OS in background
- Serial EEPROM 256 Kb
- PWM output
- Programmable HW timer
- · Battery monitoring
- 12 pins (9 I/O pins, 1 input only pin)
- A/D converter (3 channels)
- Analog comparator
- Vertical mounting, SIM card compatible
- · Shielding can
- Small dimensions

Applications

- Bidirectional RF communication
- Point-to-point or network wireless connectivity
- Telemetry, AMR (automatic meter reading)
- WSN (wireless sensor network)
- · Building automation
- Street lighting control
- · Wireless monitoring, control and regulation
- · Remote data acquisition
- RF connectivity in many other fields
- Also for municipal and indoor areas
- Internet of Things

Block diagram





The information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets your specifications.

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Electrical specifications

Typical values unless otherwise stated

Parameters specified in this datasheet are typical values. They are at power supply Vcc = 3 V only. Vcc voltage different from 3 V can impact on RF range and other parameters.

Supply voltage (V_{CC}) ¹ 3.0 V min., 3.4 V max., stabilized

-40 °C to +85 °C Operating temperature ²

Supply current

Deep sleep mode (OS v4.00 or higher only)

Sleep mode

56 nA (all peripherals disabled 4, RF IC in Standby mode) 610 nA (all peripherals disabled 4, RF IC in Sleep mode)

Run mode

RF sleep 1.6 mA 3.0 mA

RF ready

STD LP 5

RX mode

11.8 mA 250 µA XLP 5 $16.3 \mu A$

TX mode 8.3 mA – 21.5 mA (according to RF output power)

Additional LED supply current About 2 mA per LED. Rough value for brief guidance only.

RF band 868 MHz or 916 MHz (software configurable)

RF channels See IQRF OS User's guide, Appendix Channel maps

GFSK (Gaussian Frequency Shift Keying) RF data modulation

RF data transmission bit rate 6

1.5 (according to ETSI EN 300 220-1 V3.1.1) RF receiver category

RF sensitivity 7 -101 dBm (STD RX mode, checkRF (0)). See Diagram 4.

Up to 6.5 dBm ^{3A}, 11 dBm ^{3B} (868 MHz band), 2.0 to 6.5 dBm (916 MHz band).), Effective radiated power 3,7

programmable in 8 levels (0-7). See Diagrams 2A, 2B.

Antenna PCB meander line, linear polarization, omnidirectional. See Diagram 1.

RF range 500 m ^{3A}, 1100 m ^{3B}

Input voltage on I/O pins 0 V to VCC

A/D converter 10 bit, 3 inputs. Refer to MCU datasheet.

Size (L x W x H) 27.5 mm x 14.9 mm x 3.3 mm

Note 1: RF power and other parameters depend on the supply voltage. Refer to datasheets of MCU and RF IC used. Test your application with respect to required supply voltage range.

Note 2: RF range may change with lower temperature. Frost, condensation or humidity over 85% may disable module functionality. Module suitability should be tested in the final application at real conditions before volume use.

Note 3: Arrangement: Two TR-75DA transceivers plugged in DK-EVAL-04A kits, vertically, 1.6 m above the ground, in free space, bidirectional communication.

3A: TR-75DA transceivers plugged directly in DK-EVAL-04A kits.

3B: TR-75DA transceivers plugged in DK-EVAL-04A kits through the RNG-EXT-01 adapters.

Test software: E09-LINK example (STD mode, setRFpower (7), checkRF(0)), bit rate 19.8 kb/s.

Note 4: Additional current is consumed when a peripheral (e.g. watchdog. Brown-out detection etc.) is enabled.

Note 5: Depends on interferences.

Note 6: Several RF bit rates different from 19.8 kb/s will be available in future IQRF OS versions.

Note 7: RF circuitry, RF balun and built-in PCB antenna included.

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Absolute maximum ratings

Stresses above listed maximum values may cause permanent damage to the device and affect device reliability. Functional operation under these or any other conditions beyond those specified is not supported.

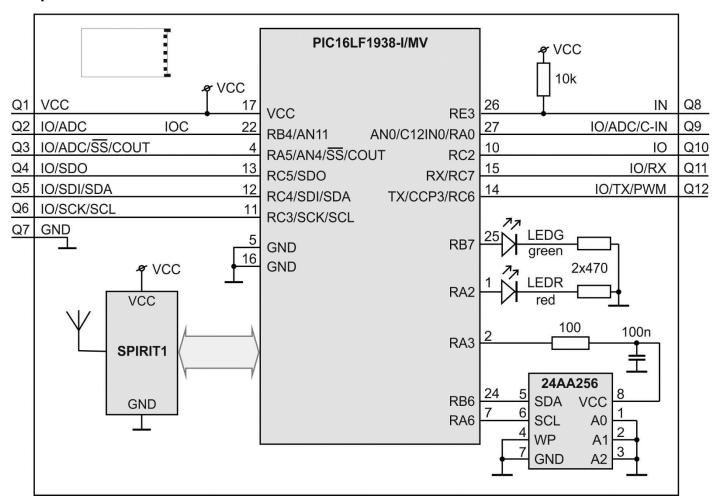
Supply voltage (Vcc) 3.9 V

Voltage on I/O pins (configured as inputs) vs. GND -0.3 V to (Vcc + 0.3 V)

Storage temperature -40 °C to +85 °C
Ambient temperature under bias -40 °C to +85 °C

Caution: Electrostatic sensitive device. Observe appropriate precautions for handling.

Simplified schematic

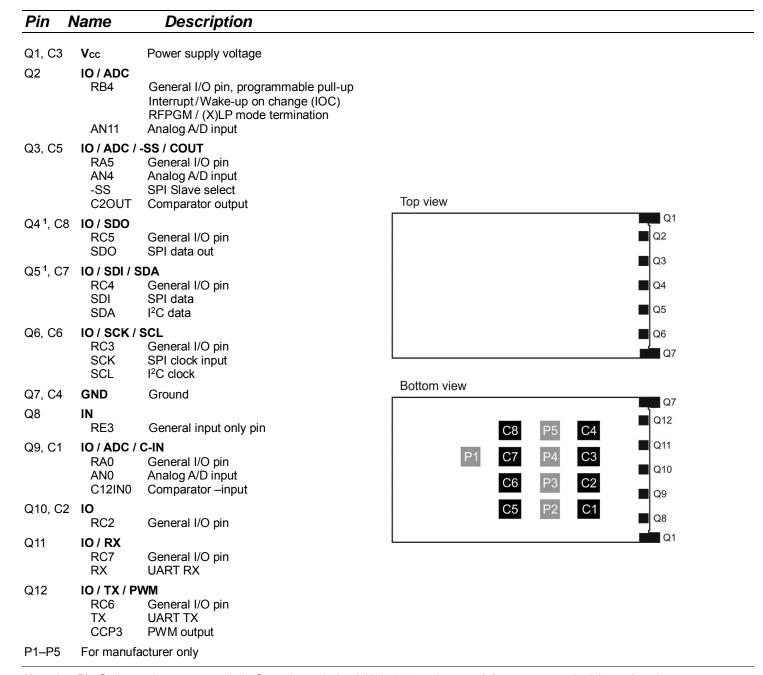


Basic components

IC	Туре	Manufacturer	Note
MCU	PIC16LF1938–I/MV	Microchip	
RF IC	SPIRIT1	STMicroelectronics	
RF balun	BALF-SPI-01D3	STMicroelectronics	
EEPROM	24AA256-I/CS16K	Microchip	256 Kb

For more information refer to datasheets of ICs used.

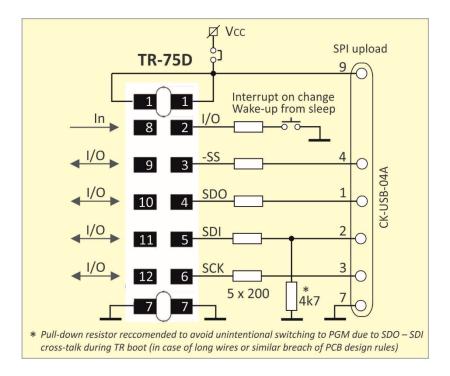




Note 1: Pin Q4 is used as output and pin Q5 as input during initial ~200 ms boot-up (after power supply rising-up) to detect programming mode. That is why these two pins should not be interconnected to each other.

There are no on-board protection series resistors on I/O pins. It is recommended to use 200 Ω series resistors on each pin.

Recommended circuit for development



For development, it is recommended to implement the following arrangement:

- Serial protective resistors on each I/O pin used.
- Pin Q2 configured as an input with the internal pull-up resistor and equipped with a pushbutton connected to the ground.
 Then pressing the button can generate an interrupt on pin change, wake-up the transceiver from sleep, terminate RFPGM mode, initiate bonding etc.
- Pull-down resistor on pin Q5 recommended to avoid unintentional switching to PGM mode due to SDO SDI cross-talk during TR boot (in case of long wires or similar breach of PCB design rules only).
- SPI interface for wired upload of application code into the transceiver using an IQRF programmer, e.g CK-USB-04A.

Depending on actual user application and power supply range, it may be required to isolate interface pins and/or power supply from user circuitry during uploading. For details refer to the CK-USB-04A User's guide, chapter *Application/Incircuit upload*.



RF range

RF range strongly depends on the following design aspects:

- Hardware:
 - Construction of the devices (especially TR location within the device, PCB layout, ground planes, conductive areas and bulk objects such as metallic parts and batteries in the nearest surroundings, with respect to possible reflections and counterpoise effect). To achieve an efficient range and reliable connectivity, no parts impacting the range must be placed close to the built-in meander antenna. Even non-conductive parts can significantly impact the range.
 - Physical arrangement of devices (especially mutual orientations of antennas with respect to polarizations and radiation patterns)
- · Application software:
 - RF output power is selectable from 8 levels
 - To increase immunity to RF noise, incoming RF signal can be filtered according to signal strength.

Refer to IQRF OS Reference guide, function checkRF and Application note AN014 RF range optimizing at TR-7xDx transceivers.

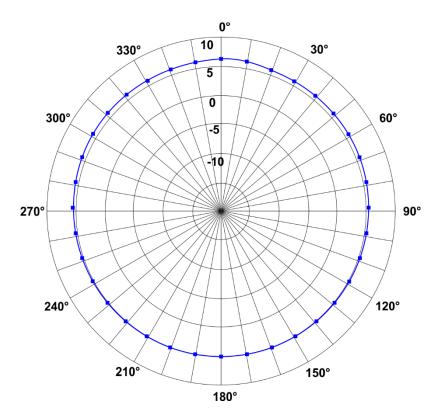
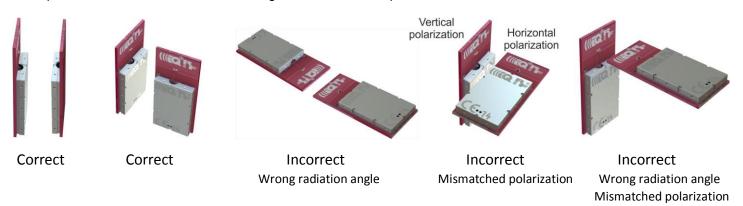


Diagram 1: TR-75DA RF output power [in dBm] vs. antenna orientation (radiation patterns) in horizontal plane, when the antenna is oriented vertically.

Examples of the correct and incorrect arrangement of TR-7xDA pairs:





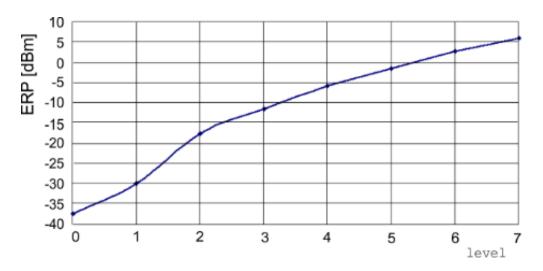


Diagram 2A: Effective radiated power (ERP) vs. level in the setRFpower (level) function. TR-75DA, 868 MHz band, channels 0 to 67. Refer to IQRF OS Reference guide.

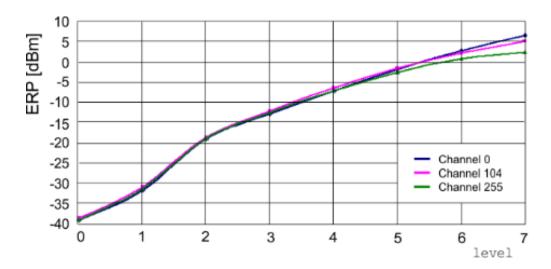


Diagram 2B: Effective radiated power (ERP) vs. level in the setRFpower (level) function. TR-75DA, 916 MHz band. Refer to IQRF OS Reference guide.

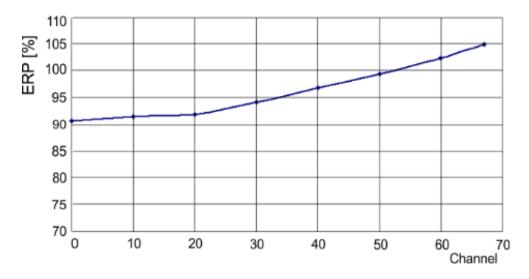


Diagram 3A: Relative effective radiated power (ERP) vs. channel, with respect to channel 52 (100 %). TR-75DA, 868 MHz band.

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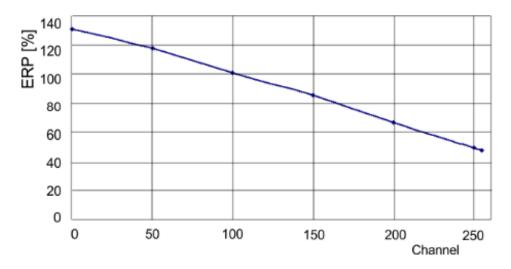


Diagram 3B: Relative effective radiated power (ERP) vs. channel, with respect to channel 104 (100%). TR-75DA, 916 MHz band.

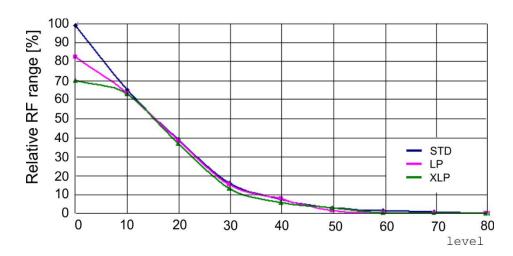


Diagram 4: Relative RF range vs. level in the checkRF (level) function in STD, LP and XLP RX modes. Refer to IQRF OS Reference guide.

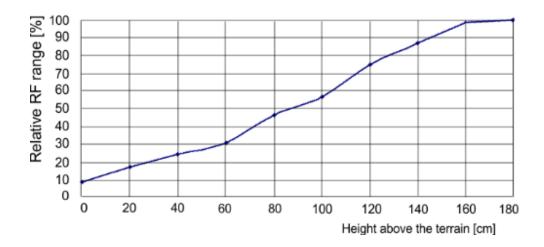
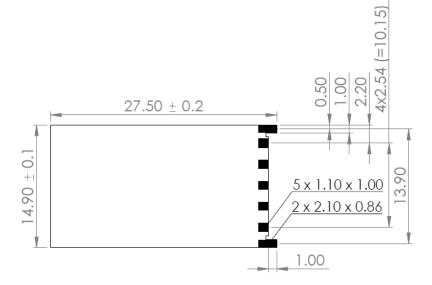


Diagram 5: Relative RF range vs. antenna height above the ground. TR-75DA, 868 MHz and 916 MHz bands.

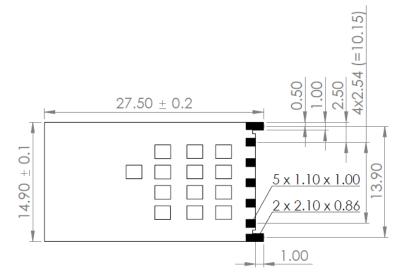


Mechanical drawings

Top



Bottom



Units: mm.

Hardware revision

• TR-75DA v1.00 First release.

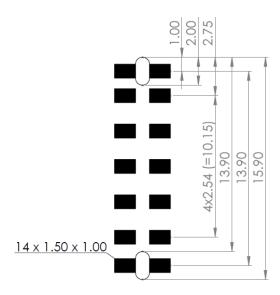


Application

Users have to ensure observing local provisions and restrictions relating to the use of short-range devices **by software**, e.g. the CEPT ERC/REC 70-03 Recommendation and subsequent amendments in EU.

See IQRF video tutorial set on www.igrf.org/videos.

Recommended PCB layout



Sealing

In case of sealing or protecting TR modules against a harsh environment by coating, encapsulating or potting using a lacquer, gel or other filling matter, the ion cleanness of the TR modules must be less than 1 μ g/cm² of NaCl equivalent otherwise there is a risk of corrosion.

Such a surface treatment always impacts the RF range. Thus, sealing material should have the relative permeability (μ_r) as close to 1 within given frequency band. E.g. $\mu_r = 4$ at 868 MHz decreases relative range to approx. 70%.

Protecting materials, methods, accomplishments and handling must comply with general requirements and rules for proper use with electronic devices. Damaging, either chemical or mechanical (even due to the thermal expansivity of the material used) must be avoided. Testing is necessary to ensure that the application meets the specifications.

Operating system

See IQRF OS User's guide and IQRF OS Reference guide.

DPA framework

See DPA Framework technical guide.

Application software

See IQRF Quick start guide and IQRF application examples.

Programming (upload)

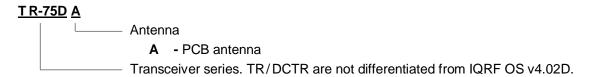
There are the following possibilities to upload an application program in TR-75Dx transceivers:

- Wired upload with TR-75Dx plugged via the SIM connector in the CK-USB-04A programmer.
- For TR-75Dx modules populated in an application:
 - · Wired upload
 - Using the CK-USB-04A programmer. See the CK-USB-04A User's guide.
 - Using the CK-USB-04 programmer and the KON-TR-01P adapter. See the KON-TR-01P User's guide.
 - Wireless upload: See the IQRF OS User's guide, Appendix RFPGM RF programming™.



Product information

Ordering codes



Туре	Antenna connection	Data controlled
TR-75DA	PCB antenna	Yes

Document history

- 180130 Block diagram revised. RF parameters in chapter *Electrical specifications* revised. A bug in *Note 1* in pin description table fixed. Chapter *RF range* extended. Directives in *Quality management* updated.
- 171108 First release. Preliminary.



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